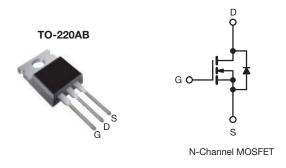
Vishay Siliconix



EL Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.105			
Q _g max. (nC)	120				
Q _{gs} (nC)	14				
Q _{gd} (nC)	19				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP30N60AEL-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-source voltage		V _{DS}	600	V			
Gate-source voltage	V _{GS}	± 30	7 V				
Continuous drain current (T _J = 150 °C)	$V_{GS} \text{ at 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	- I _D	28				
	V_{GS} at 10 V $T_C = 100 \text{ °C}$		18	A			
Pulsed drain current ^a	I _{DM}	68					
Linear derating factor			2	W/°C			
Single pulse avalanche energy ^b		E _{AS}	353	mJ			
Maximum power dissipation		PD	250	W			
Operating junction and storage temperature ran	ge	T _J , T _{stg}	-55 to +150	°C			
Reverse diode dv/dt ^d		dv/dt	32	V/ns			
Soldering recommendations (peak temperature)	c For 10 s		260	°C			

Notes

• Initial samples marked as SiHP30N60BE

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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ROHS COMPLIANT

HALOGEN

FREE



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 62			0044				
Maximum junction-to-case (drain)	R _{thJC}	- 0.5				°C/W			
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	nless otherwi	se noted)							
PARAMETER	SYMBOL			NS	MIN.	TYP.	MAX.	UNIT	
Static		1				1		1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250	μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D	= 1 mA	-	0.68	-	V/°C	
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250) μA	2.0	-	4.0	V	
		```	$V_{\rm GS} = \pm 20  \rm V$		-	-	± 100	nA	
Gate-source leakage	I _{GSS}	````	/ _{GS} = ± 30 V		-	-	± 1	μA	
		V _{DS} =	600 V, V _{GS} =	0 V	-	-	1	μA	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V, T	_J = 125 °C	-	-	10		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =	15 A	-	0.105	0.120	Ω	
Forward transconductance	g _{fs}	V _{DS}	= 20 V, I _D = 15	5 A	-	19	-	S	
Dynamic		1 -			1	1	I		
Input capacitance	C _{iss}		V _{GS} = 0 V, V _{DS} = 100 V,		-	2565	-		
Output capacitance	C _{oss}	- -			-	109	-		
Reverse transfer capacitance	C _{rss}	f = 1  MHz - V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	6	-	pF		
Effective output capacitance, energy related ^a	C _{o(er)}			-	71	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	367	-			
Total gate charge	Qg				-	60	120	nC	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 15 A, V	V _{DS} = 480 V	-	14	-		
Gate-drain charge	Q _{gd}	-			-	19	-	1	
Turn-on delay time	t _{d(on)}				-	26	52		
Rise time	t _r	V _{DD} =	480 V, I _D = 1	5 A,	-	24	48	1	
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	79	158	ns	
Fall time	t _f			-	33	66	1		
Gate input resistance	Rg	f = 1 MHz, open drain		0.35	0.72	1.45	Ω		
Drain-Source Body Diode Characteristic		•					ı		
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	26			
Pulsed diode forward current	I _{SM}			-	-	68	A		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 15 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	335	670	ns		
Reverse recovery charge	Q _{rr}			-	5.4	10.8	μC		
Beverse recovery current	IDDM			<u> </u>	30		Δ.		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

 $I_{\text{RRM}}$ 

Reverse recovery current

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

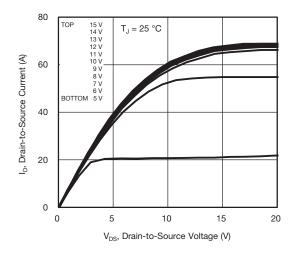
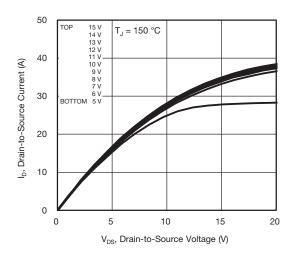
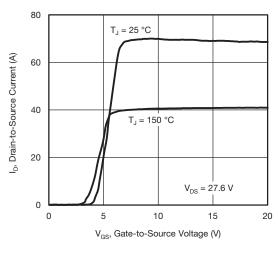


Fig. 1 - Typical Output Characteristics









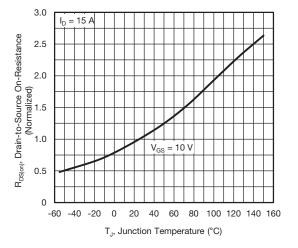


Fig. 4 - Normalized On-Resistance vs. Temperature

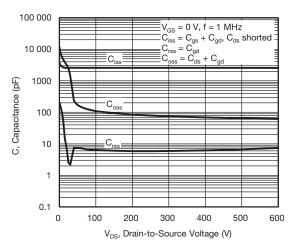


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

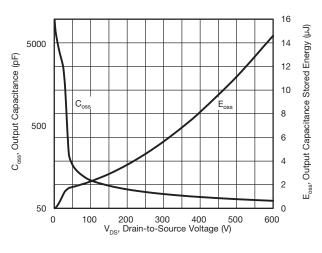


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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V_{DS} = 480 V  $V_{DS} = 300 V$ V_{DS} = 120 V Gate-to-Source Voltage (V) 9 6 3 V_{GS}, 0 75 0 15 30 45 60 Q_q, Total Gate Charge (nC)

Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

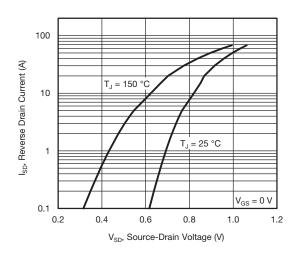


Fig. 8 - Typical Source-Drain Diode Forward Voltage

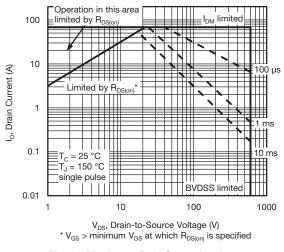


Fig. 9 - Maximum Safe Operating Area

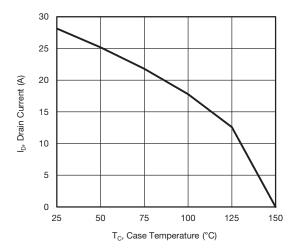


Fig. 10 - Maximum Drain Current vs. Case Temperature

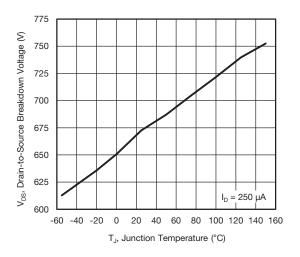


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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SiHP30N60AEL

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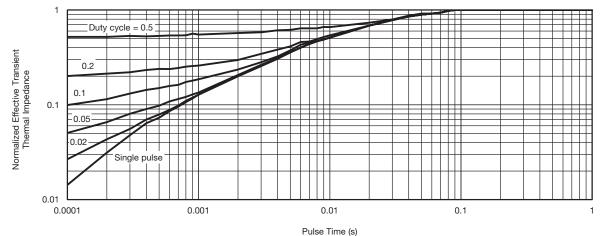


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

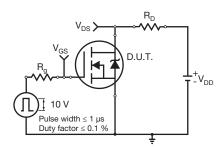


Fig. 13 - Switching Time Test Circuit

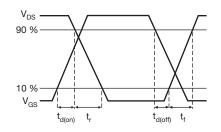


Fig. 14 - Switching Time Waveforms

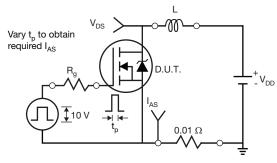


Fig. 15 - Unclamped Inductive Test Circuit

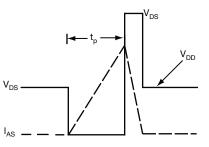


Fig. 16 - Unclamped Inductive Waveforms

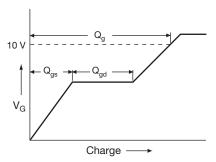


Fig. 17 - Basic Gate Charge Waveform

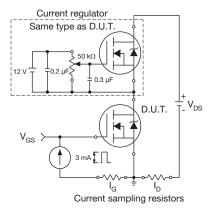


Fig. 18 - Gate Charge Test Circuit

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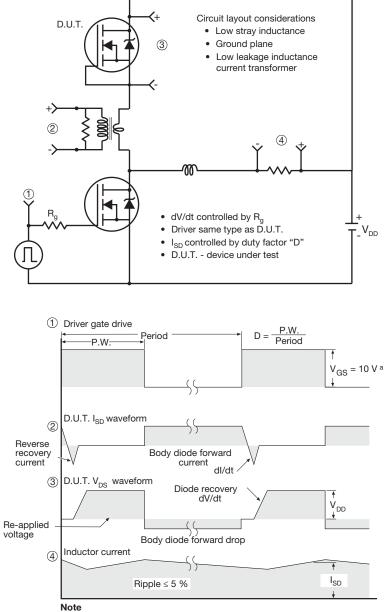
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

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